



MAT SCIENCE 2026

November 09-10, 2026 (In-Person)

Location: Park Hotel, Hong Kong

November 11, 2026 (Virtual Via Zoom Platform)

Welcome Message

Join us at the International Conference on Materials Science and Engineering (Mat Science 2026) on November 9–11, 2026 at Park Hotel, Hong Kong. Mat Science 2026 brings together global participants under the theme **“Shaping the Future through Expertise and Innovations in Materials Science and Engineering.”** Connect with academicians, researchers, industry professionals, and scientists to share insights and engage in meaningful discussions. Don't miss the opportunity to showcase your research and innovations. We look forward to welcoming you to Hong Kong.

About the Event

Join Mat Science 2026 in Hong Kong for a premier international conference in materials science and engineering. Experience dedicated collaboration spaces, breakout sessions, and valuable networking opportunities. Engage with global experts, explore the latest advancements, and connect with professionals in research, academia, and industry. The program features keynote lectures, oral sessions, workshops, and interactive discussions. Discover cutting-edge innovations and elevate your professional growth at this global platform.

For more details click here:

<https://materialsscience.mindauthors.com/>

We do have several topics for the conference. You can choose any of the topics which you would like to present at the Conference such as:

1. Materials Science and Engineering
2. Nanomaterials and Nanotechnology
3. Biomaterials and Healthcare
4. Materials for Energy and Environmental Sustainability
5. Advanced Energy Materials
6. Emerging Smart Materials & many more

click here: <https://materialsscience.mindauthors.com/submit-abstract/>

Featured Speakers



Sonia P. M. Ventura
University of Aveiro,
Portugal



Kwun Nam Hui
University of Macau,
China



Yugo Osaka
Kanazawa university,
Japan



Liviu Popa-Simil
LAAS-Los Alamos Academy
of Sciences, USA



Yoshiyuki Kawazoe
New Industry Creation
Hatchery Center, Tohoku
University, Japan



Yiyuan Yang
National University of
Singapore, Singapore



Michael A Morris
Trinity College Dublin
and HTMS, Ireland



Qing Chen
Peking University,
China



Kriveshini Pillay
University of
Johannesburg, South
Africa



Kenji Uchino
The Pennsylvania
State University, USA



Shuiquan Deng
Chinese Academy
of Sciences, China



Jun Chen
University of California,
Los Angeles, United
State



Alei Dang
Northwestern
Polytechnical
University, China



Ligu Shen
Zhejiang Normal
University, China



Dou Zhang
Harbin Institute of
Technology, China

REGISTRATION BENEFITS

- One Presenter/Listener Slot
- Participation Certificate
- Access to conference sessions and panel discussion
- Conference Kit
- Access to all the conference rooms
- Access to Conference Recordings & Photos
- University Logo placement on banners
- Abstract Book
- Access to all virtual conferences as a Listener for one year from the date of the conference.
- Lunch during the conference

CITY ATTRACTIONS

- Victoria Peak
- Victoria Harbour
- Tian Tan Buddha
- Tsim Sha Tsui Promenade
- Star Ferry

Registration fee Details

Conference Date	Fee
Speaker	\$599
Poster	\$649
Delegate/Listener	\$699
Package A	\$1199
Package B	\$1399
Package C	\$1599
Group (For Three)	\$1697
Group (For Five)	\$2745
Group (For Seven)	\$3893
Virtual	\$399
YRF/ Students	\$499
E-Poster	\$299

Important Dates

Conference Date	November 9-11, 2026
Abstract Submission Opens	December 4, 2025
Registration Opens	December 5, 2025
Final Abstract Submission	October 30, 2026
Final Registration	October 31, 2026

Venue



CITY ATTRACTIONS

**BOOKMARK
YOUR DATES**
November 9, 10 & 11, 2026

We look forward to meeting you in Hong Kong, an enriching knowledge experience awaits your presence. Let's make memories together to be cherished later.